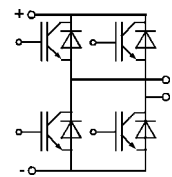
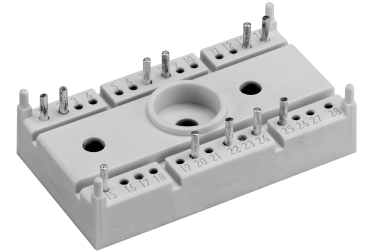


### SEMITOP® 3 IGBT Module

### SK 45 GH 063



GH

Absolute Maximum Ratings			
Symbol	Conditions <sup>1)</sup>	Values	Units
V <sub>CEs</sub>		600	V
V <sub>GES</sub>		± 20	V
I <sub>C</sub>	T <sub>h</sub> = 25/80 °C	45 / 30	A
I <sub>CM</sub>	t <sub>p</sub> < 1 ms; T <sub>h</sub> = 25/80 °C	90 / 60	A
I <sub>F</sub> = -I <sub>C</sub>	T <sub>h</sub> = 25/80 °C	57 / 38	A
I <sub>FM</sub> = -I <sub>CM</sub>	t <sub>p</sub> < 1 ms; T <sub>h</sub> = 25/80 °C	114 / 76	A
T <sub>j</sub>		- 40 ... + 150	°C
T <sub>stg</sub>		- 40 ... + 125	°C
T <sub>sol</sub>	Terminals, 10 s	260	°C
V <sub>isol</sub>	AC, 1 min	2500	V

Characteristics					
Symbol	Conditions <sup>1)</sup>	min.	typ.	max.	Units
V <sub>CEsat</sub>	I <sub>C</sub> = 30 A; T <sub>j</sub> = 25 (125) °C	-	1,8(2,0)	-	V
t <sub>d(on)</sub>	V <sub>CC</sub> = 300 V; V <sub>GE</sub> = ± 15 V I <sub>C</sub> = 30 A, T <sub>j</sub> = 125 °C R <sub>Gon</sub> = R <sub>Goff</sub> = 22 Ω inductive load	-	45	-	ns
t <sub>r</sub>		-	35	-	ns
t <sub>d(off)</sub>		-	250	-	ns
t <sub>f</sub>		-	25	-	ns
E <sub>on</sub> + E <sub>off</sub>		-	2,65	-	mJ
C <sub>ies</sub>		-	2,8	-	nF
R <sub>thjh</sub> <sup>3)</sup>		-	-	1,0	K/W
Inverse Diode <sup>2)</sup>					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 30 A; T <sub>j</sub> = 25 (125) °C	-	1,3(1,2)	1,5(1,45)	V
V <sub>TO</sub>	T <sub>j</sub> = 125 °C	-	0,85	0,9	V
r <sub>T</sub>	T <sub>j</sub> = 125 °C	-	8	16	mΩ
I <sub>RRM</sub>	I <sub>F</sub> = 30 A; V <sub>R</sub> = 300 V di <sub>F</sub> /dt = - 500 A/μs	-	30	-	A
Q <sub>rr</sub>		-	3,0	-	μC
E <sub>off</sub>		V <sub>GE</sub> = 0 V; T <sub>j</sub> = 125 °C	-	0,9	-
R <sub>thjh</sub> <sup>3)</sup>	per Diode	-	-	1,2	K/W
Mechanical Data					
M <sub>1</sub>	mounting torque	-	-	2,5	Nm
w		-	30	-	g
Case		T 19			

#### Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- N channel, homogeneous Silicon structure (NPT-Non punch-through IGBT)
- High short circuit capability
- Low tail current with low temperature dependence
- UL recognized, file no. E 63 532

#### Typical Applications

- Switching (not for linear use)
- Inverter
- Switched mode power supplies
- UPS

<sup>1)</sup> T<sub>h</sub> = 25 °C, unless otherwise specified

<sup>2)</sup> CAL = Controlled Axial Lifetime Technology ( soft and fast recovery)

<sup>3)</sup> Thermal resistance junction to heatsink

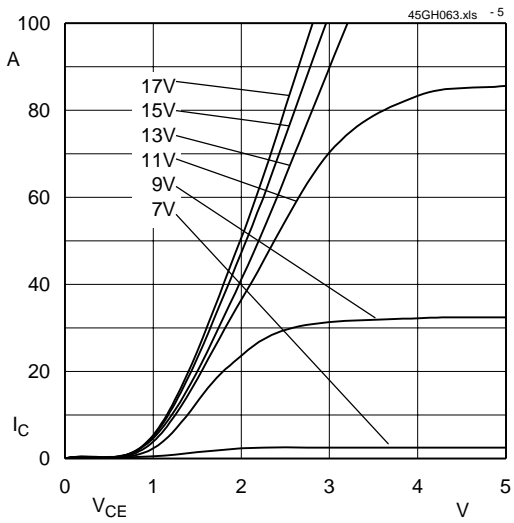


Fig. 5 Typ. output characteristic,  $t_p = 80 \mu s$ ;  $25 \text{ }^\circ\text{C}$

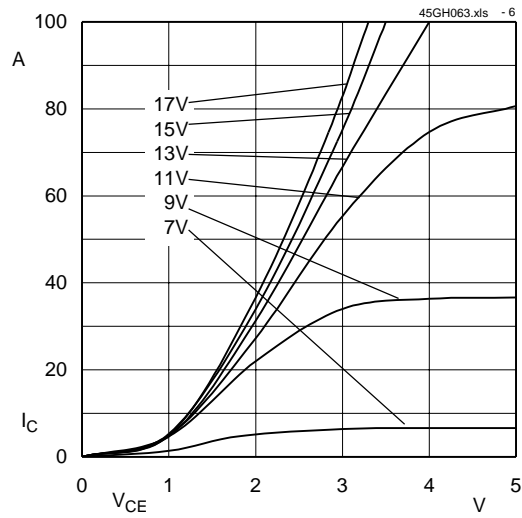


Fig. 6 Typ. output characteristic,  $t_p = 80 \mu s$ ;  $125 \text{ }^\circ\text{C}$

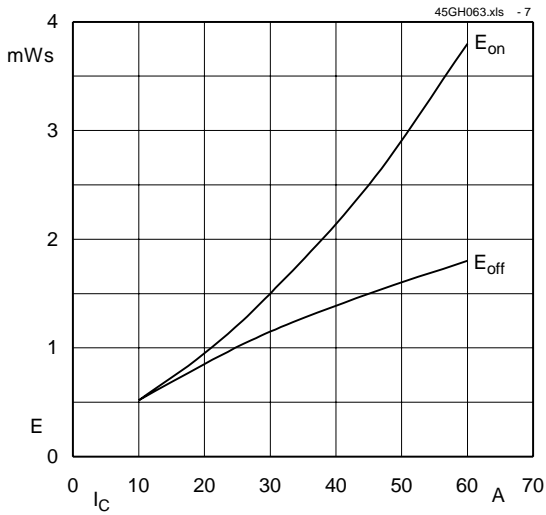


Fig. 7 Turn-on /-off energy =  $f(I_c)$

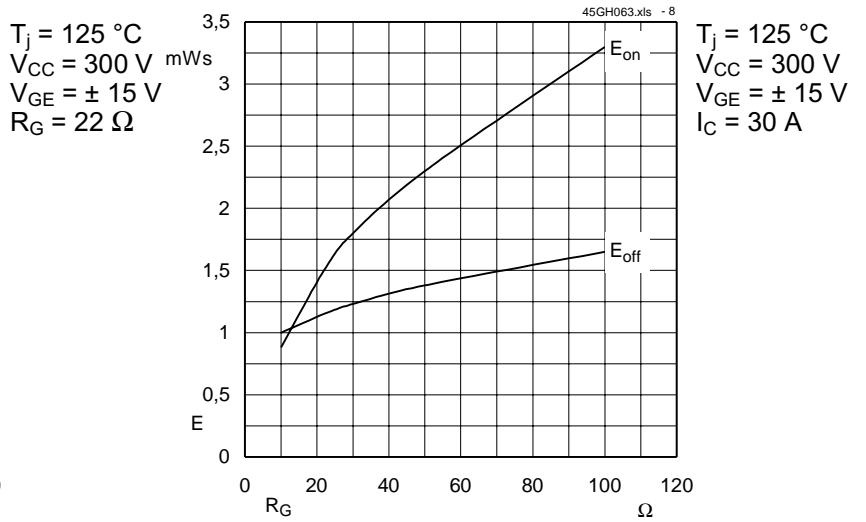


Fig. 8 Turn-on /-off energy =  $f(R_G)$

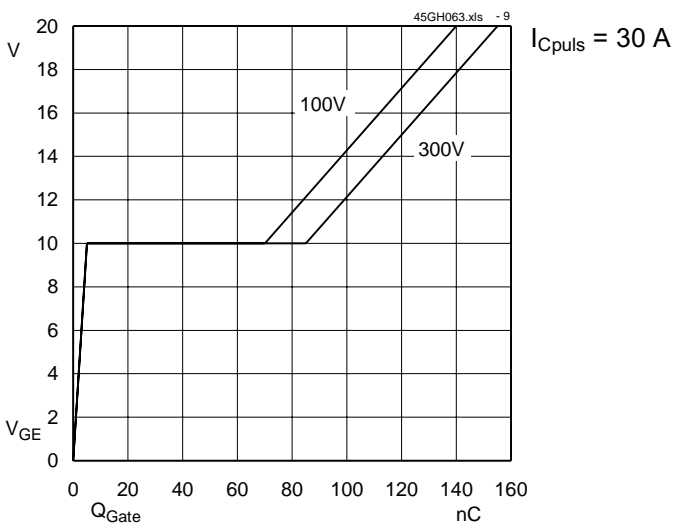


Fig. 9 Typ. gate charge characteristic

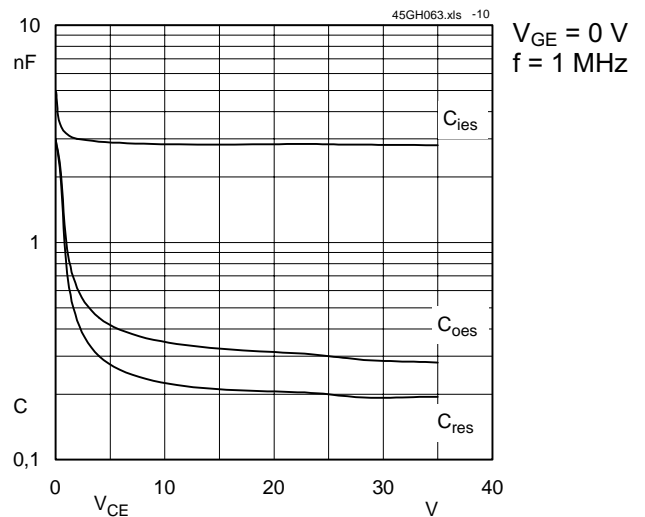


Fig. 10 Typ. capacitances vs.  $V_{CE}$

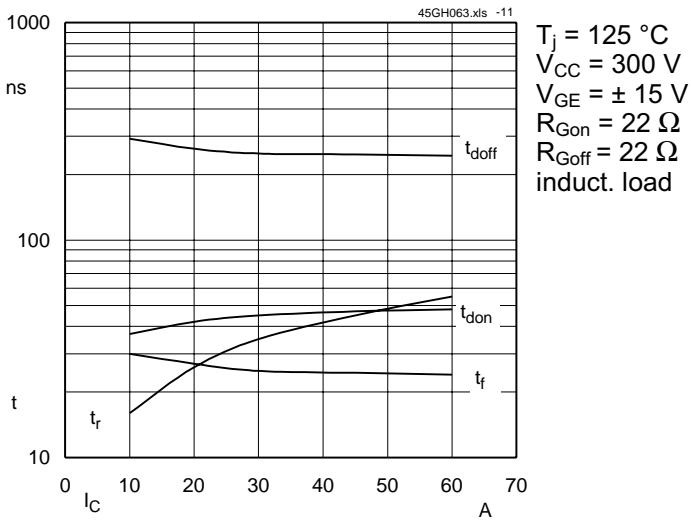


Fig. 11 Typ. switching times vs.  $I_C$

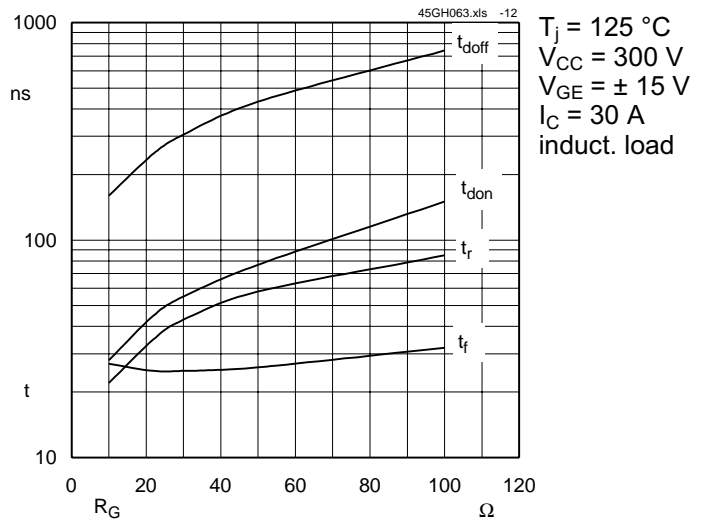


Fig. 12 Typ. switching times vs. gate resistor  $R_G$

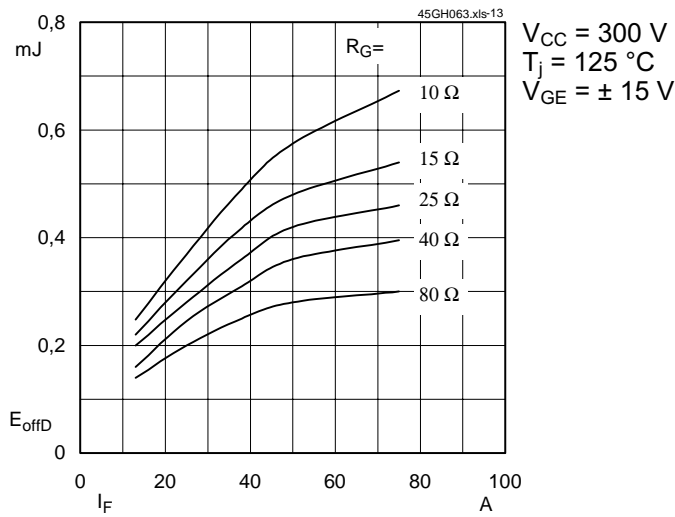
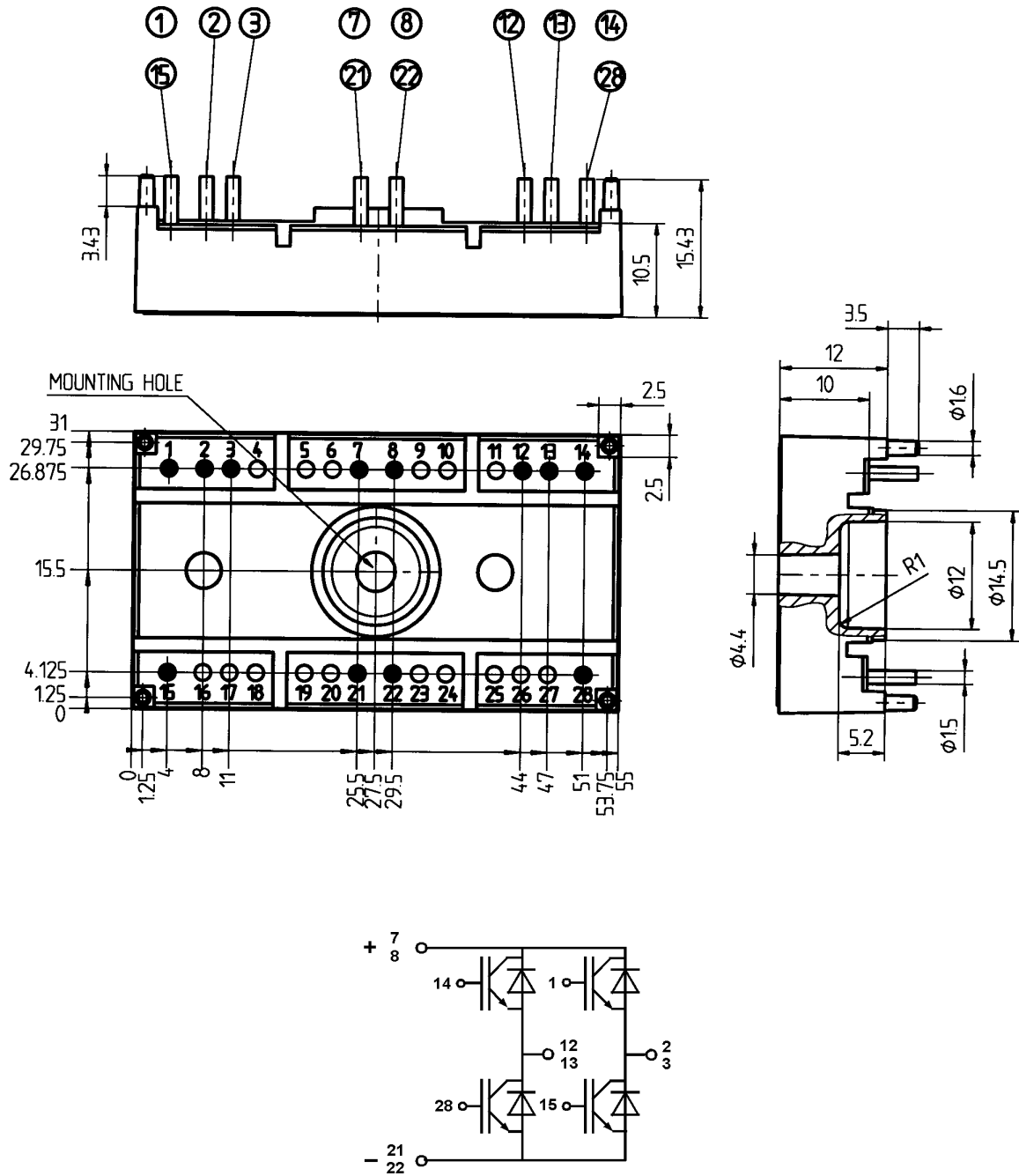


Fig. 13 Diode turn-off energy dissipation per pulse

SEMITOP® 3  
SK 45 GH 063

Case T 19



Dimensions in mm

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.